

STARPOWER

SEMICONDUCTOR™

IGBT

GD75HFU120C1S

Molding Type Module

1200V/75A 2 in one-package

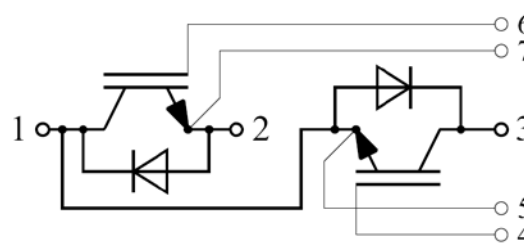
General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as UPS and SMPS.



Features

- Low $V_{CE(sat)}$ NPT IGBT technology
- Low switching losses
- 10 μ s short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology



Equivalent Circuit Schematic

Typical Applications

- UPS
- Switching mode power supplies
- Electronic welders

Absolute Maximum Ratings $T_C=25^{\circ}\text{C}$ unless otherwise noted

| Symbol | Description | GD75HFU120C1S | Units |
|-----------------|---|--------------------------|--------------------|
| V_{CES} | Collector-Emitter Voltage | 1200 | V |
| V_{GES} | Gate-Emitter Voltage | ± 20 | V |
| I_C | Collector Current @ $T_C=25^{\circ}\text{C}$ | 150 | A |
| | @ $T_C=80^{\circ}\text{C}$ | 75 | |
| $I_{CM(1)}$ | Pulsed Collector Current $t_p=1\text{ms}$ | 150 | A |
| I_F | Diode Continuous Forward Current | 75 | A |
| I_{FM} | Diode Maximum Forward Current | 150 | A |
| P_D | Maximum Power Dissipation @ $T_j=150^{\circ}\text{C}$ | 658 | W |
| T_j | Maximum Junction Temperature | 150 | $^{\circ}\text{C}$ |
| T_{STG} | Storage Temperature Range | -40 to +125 | $^{\circ}\text{C}$ |
| V_{ISO} | Isolation Voltage RMS, $f=50\text{Hz}, t=1\text{min}$ | 2500 | V |
| Mounting Torque | Power Terminal Screw:M5 Mounting Screw:M6 | 2.5 to 5.0 3.0 to 5.0 | N.m |

Notes:

(1) Repetitive rating: Pulse width limited by max. junction temperature

Electrical Characteristics of IGBT $T_C=25^{\circ}\text{C}$ unless otherwise noted**Off Characteristics**

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
|---------------|-------------------------------------|---|------|------|------|-------|
| $V_{(BR)CES}$ | Collector-Emitter Breakdown Voltage | $T_j=25^{\circ}\text{C}$ | 1200 | | | V |
| I_{CES} | Collector Cut-Off Current | $V_{CE}=V_{CES}, V_{GE}=0\text{V},$ $T_j=25^{\circ}\text{C}$ | | | 5.0 | mA |
| I_{GES} | Gate-Emitter Leakage Current | $V_{GE}=V_{GES}, V_{CE}=0\text{V},$ $T_j=25^{\circ}\text{C}$ | | | 400 | nA |

On Characteristics

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
|---------------|---|---|------|------|------|-------|
| $V_{GE(th)}$ | Gate-Emitter Threshold Voltage | $I_C=750\mu\text{A}, V_{CE}=V_{GE},$ $T_j=25^{\circ}\text{C}$ | 4.4 | 5.2 | 6.0 | V |
| $V_{CE(sat)}$ | Collector to Emitter Saturation Voltage | $I_C=75\text{A}, V_{GE}=15\text{V},$ $T_j=25^{\circ}\text{C}$ | | 3.10 | 3.60 | V |
| | | $I_C=75\text{A}, V_{GE}=15\text{V},$ $T_j=125^{\circ}\text{C}$ | | 3.45 | | |

Switching Characteristics

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
|---------------|--|---|------|------|------|------------|
| $t_{d(on)}$ | Turn-On Delay Time | $V_{CC}=600V, I_C=75A,$ $R_G=7.5\Omega, V_{GE}=\pm 15V,$ $T_j=25^\circ C$ | | 286 | | ns |
| t_r | Rise Time | | | 53 | | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | | 304 | | ns |
| t_f | Fall Time | | | 103 | | ns |
| E_{on} | Turn-On Switching Loss | | | 4.16 | | mJ |
| E_{off} | Turn-Off Switching Loss | | | 2.17 | | mJ |
| $t_{d(on)}$ | Turn-On Delay Time | $V_{CC}=600V, I_C=75A,$ $R_G=7.5\Omega, V_{GE}=\pm 15V,$ $T_j=125^\circ C$ | | 297 | | ns |
| t_r | Rise Time | | | 56 | | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | | 321 | | ns |
| t_f | Fall Time | | | 136 | | ns |
| E_{on} | Turn-On Switching Loss | | | 5.82 | | mJ |
| E_{off} | Turn-Off Switching Loss | | | 3.44 | | mJ |
| C_{ies} | Input Capacitance | $V_{CE}=30V, f=1MHz,$ $V_{GE}=0V$ | | 6.40 | | nF |
| C_{oes} | Output Capacitance | | | 0.57 | | nF |
| C_{res} | Reverse Transfer Capacitance | | | 0.23 | | nF |
| I_{SC} | SC Data | $t_{sc} \leq 10\mu s, V_{GE}=15V,$ $T_j=125^\circ C, V_{CC}=600V,$ $V_{CEM} \leq 1200V$ | | 300 | | A |
| L_{CE} | Stray Inductance | | | | 30 | nH |
| $R_{CC'+EE'}$ | Module Lead Resistance, Terminal to Chip | $T_C=25^\circ C$ | | 0.75 | | m Ω |

Electrical Characteristics of DIODE $T_C=25^\circ C$ unless otherwise noted

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
|-----------|-------------------------------|--------------------------------------|-------------------|------|------|---------|
| V_F | Diode Forward Voltage | $I_F=75A$ | $T_j=25^\circ C$ | 1.78 | 2.18 | V |
| | | | $T_j=125^\circ C$ | 1.85 | | |
| Q_r | Recovered Charge | $I_F=75A,$ | $T_j=25^\circ C$ | 3.6 | | μC |
| | | | $T_j=125^\circ C$ | 7.9 | | |
| I_{RM} | Peak Reverse Recovery Current | $V_R=600V,$ $di/dt=-1550A/\mu s,$ | $T_j=25^\circ C$ | 63 | | A |
| | | | $T_j=125^\circ C$ | 73 | | |
| E_{rec} | Reverse Recovery Energy | $V_{GE}=-15V$ | $T_j=25^\circ C$ | 2.21 | | mJ |
| | | | $T_j=125^\circ C$ | 4.48 | | |

Thermal Characteristics

| Symbol | Parameter | Typ. | Max. | Units |
|-----------------|--|------|------|-------|
| $R_{\theta JC}$ | Junction-to-Case (per IGBT) | | 0.19 | K/W |
| $R_{\theta JC}$ | Junction-to-Case (per DIODE) | | 0.49 | K/W |
| $R_{\theta CS}$ | Case-to-Sink (Conductive grease applied) | 0.05 | | K/W |
| Weight | Weight of Module | 150 | | g |

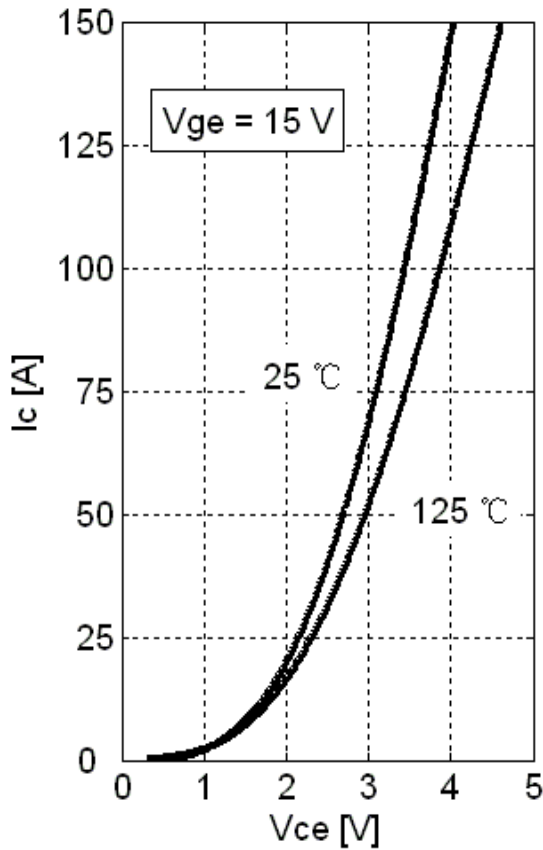


Fig 1. IGBT Typical Output Characteristics

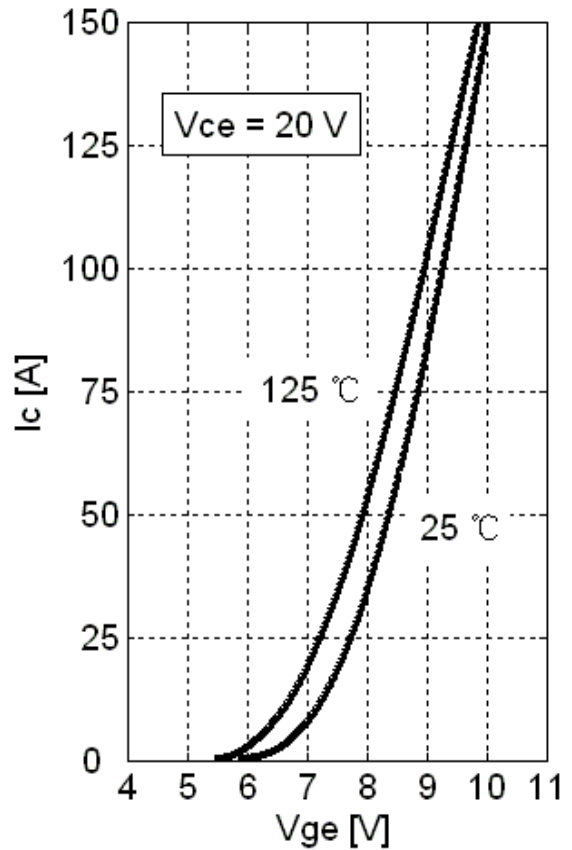


Fig 2. IGBT Typical Transfer Characteristics

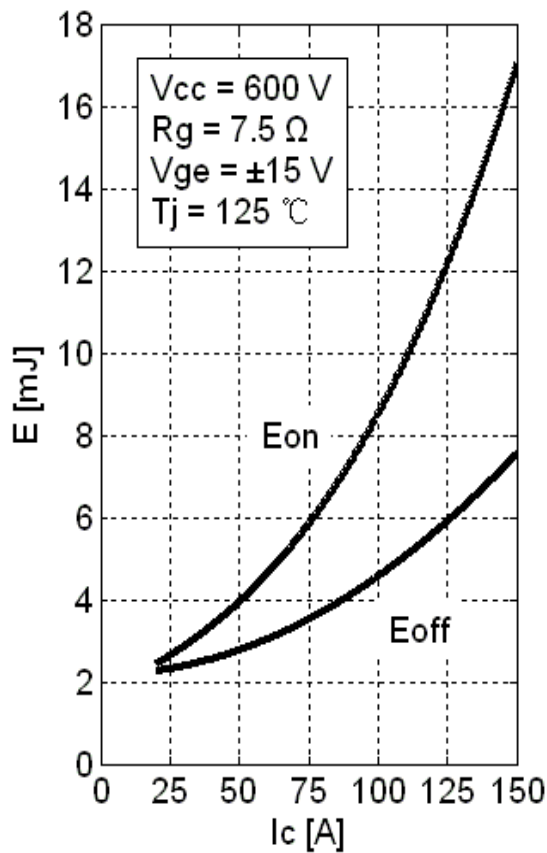


Fig 3. IGBT Switching Loss vs. I_C

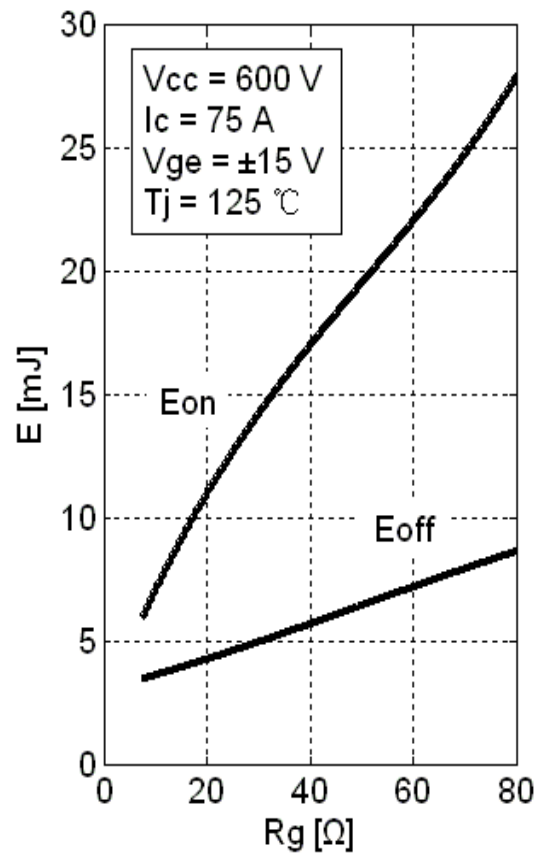


Fig 4. IGBT Switching Loss vs. R_G

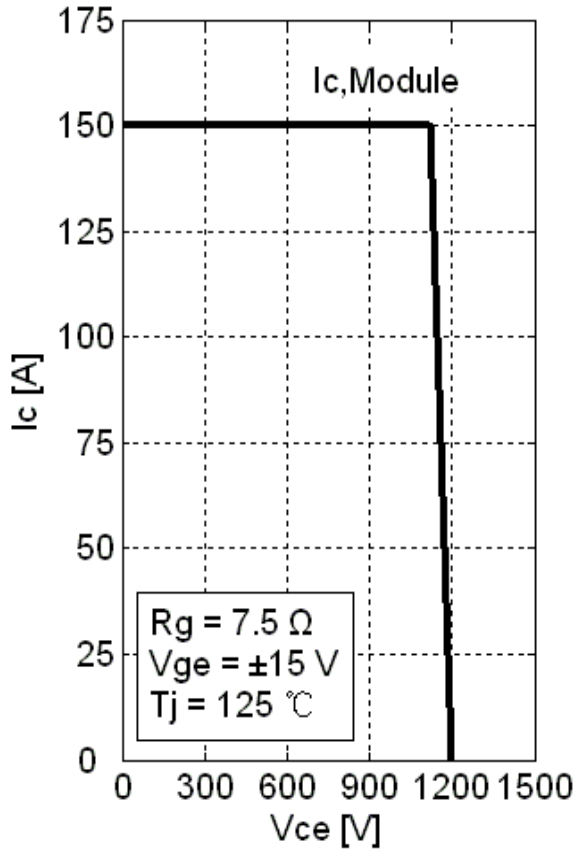


Fig 5. RBSOA

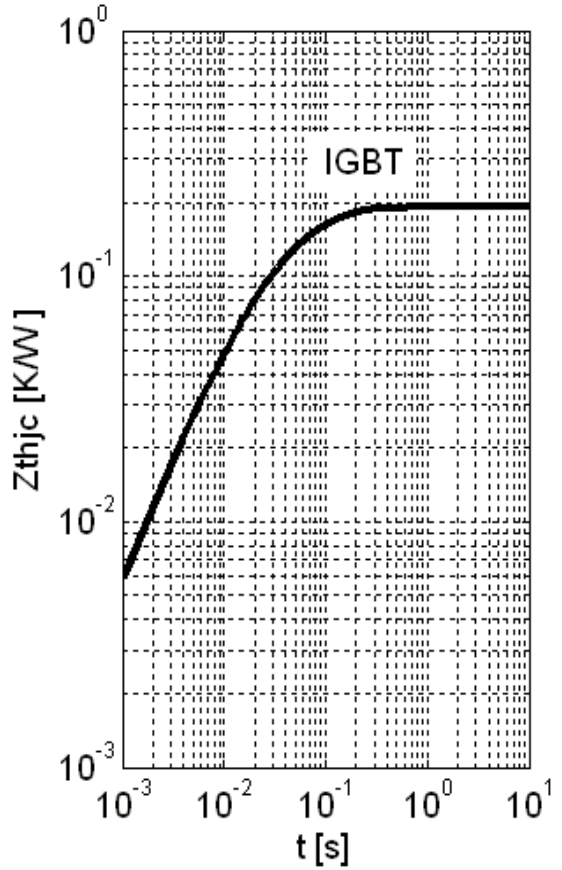


Fig 6. IGBT Transient Thermal Impedance

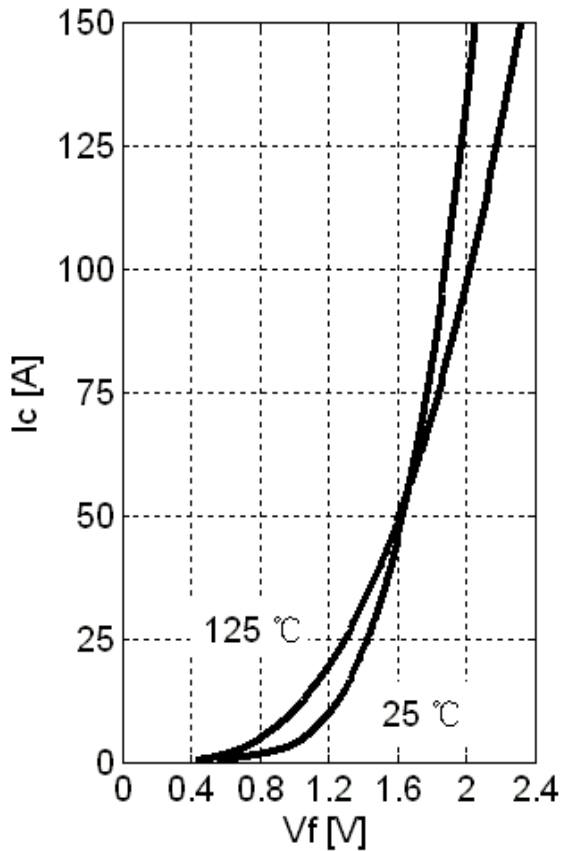


Fig 7. Diode Typical Forward Characteristics

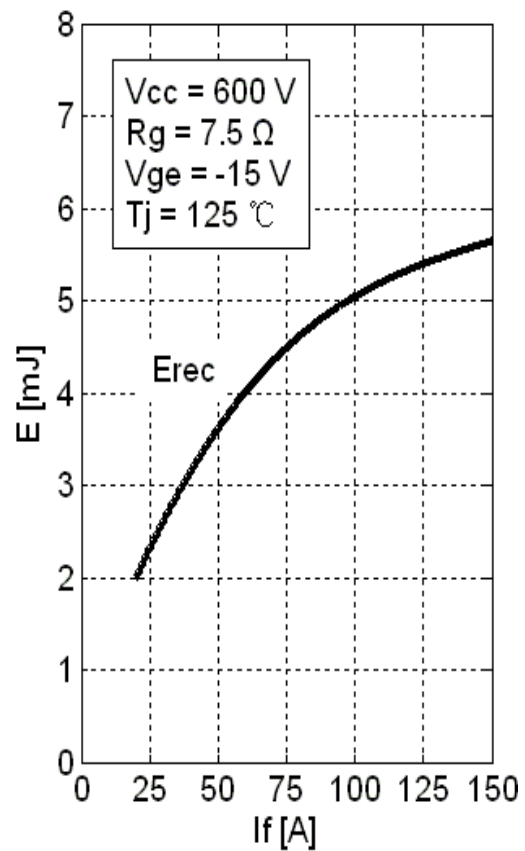


Fig 8. Diode Switching Loss vs. I_f

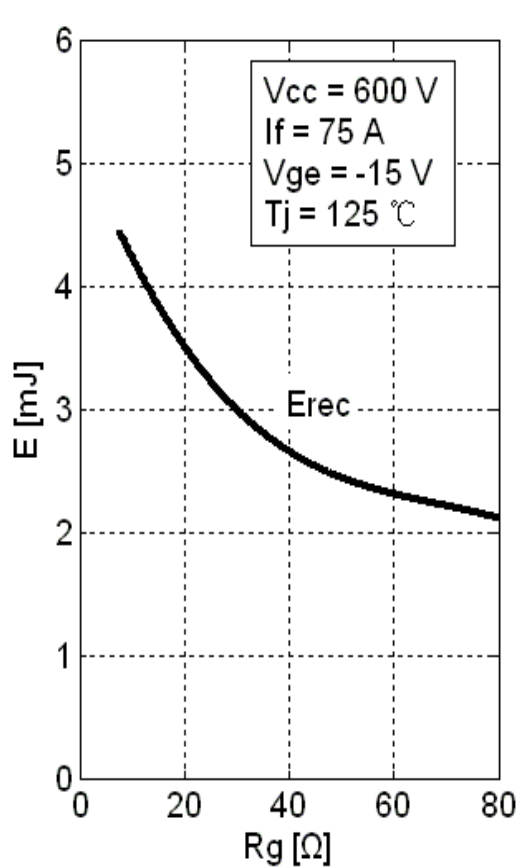


Fig 9. Diode Switching Loss vs. R_G

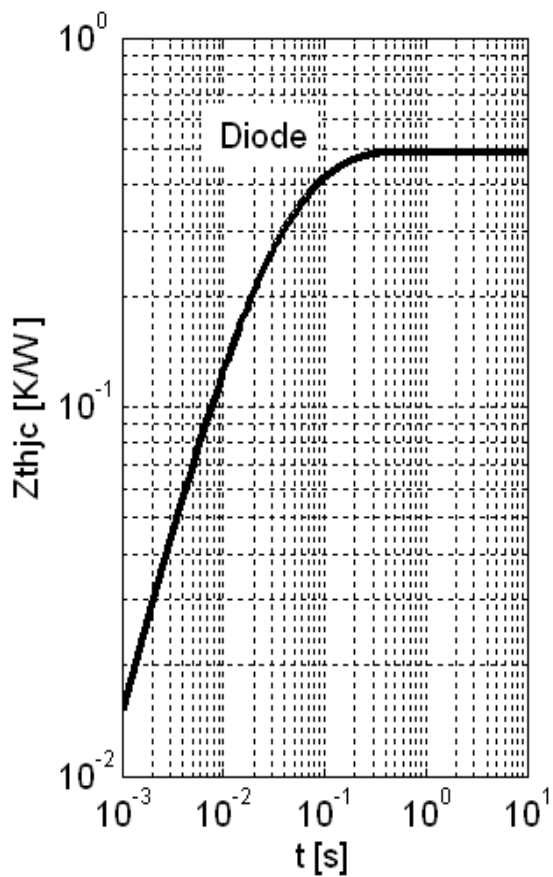
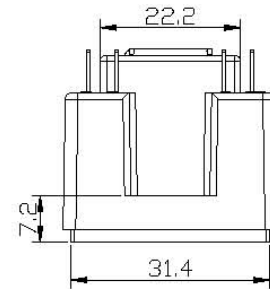
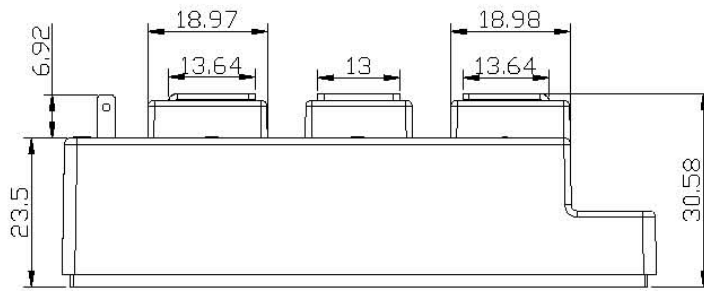
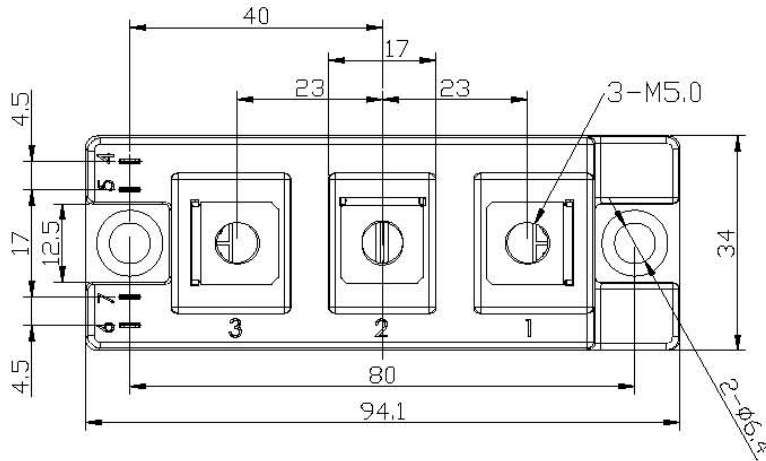


Fig 10. Diode Transient Thermal Impedance

Package Dimension

Dimensions in Millimeters



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